

# PRODUCT SPECIFICATION

**Model No.: FYLS-3806BUWC120**

Features:
<ul style="list-style-type: none"> <li>■ SMD Type</li> <li>■ Size (mm):3.80*0.60*1.00</li> <li>■ Emitting Color: White.</li> <li>■ Lens Color: Yellow Diffused.</li> <li>■ SMT package</li> <li>■ Suitable for all SMT assembly and soldering method</li> <li>■ Pb-free Reflow soldering application</li> <li>■ RoHS Compliant</li> <li>■ SIDE LED</li> <li>■ MSL:6</li> </ul>

Applications:
<ul style="list-style-type: none"> <li>■ Light Strips</li> <li>■ LCD Backlight</li> <li>■ Decorative lighting</li> <li>■ Indicators</li> <li>■ Interior automotive</li> <li>■ Illuminations</li> <li>■ Mobile Phones</li> </ul>



CUSTOMER APPROVED SIGNATURES	APPROVED BY	CHECKED BY	PREPARED BY

**NINGBO FORYARD OPTOELECTRONICS CO.,LTD.**

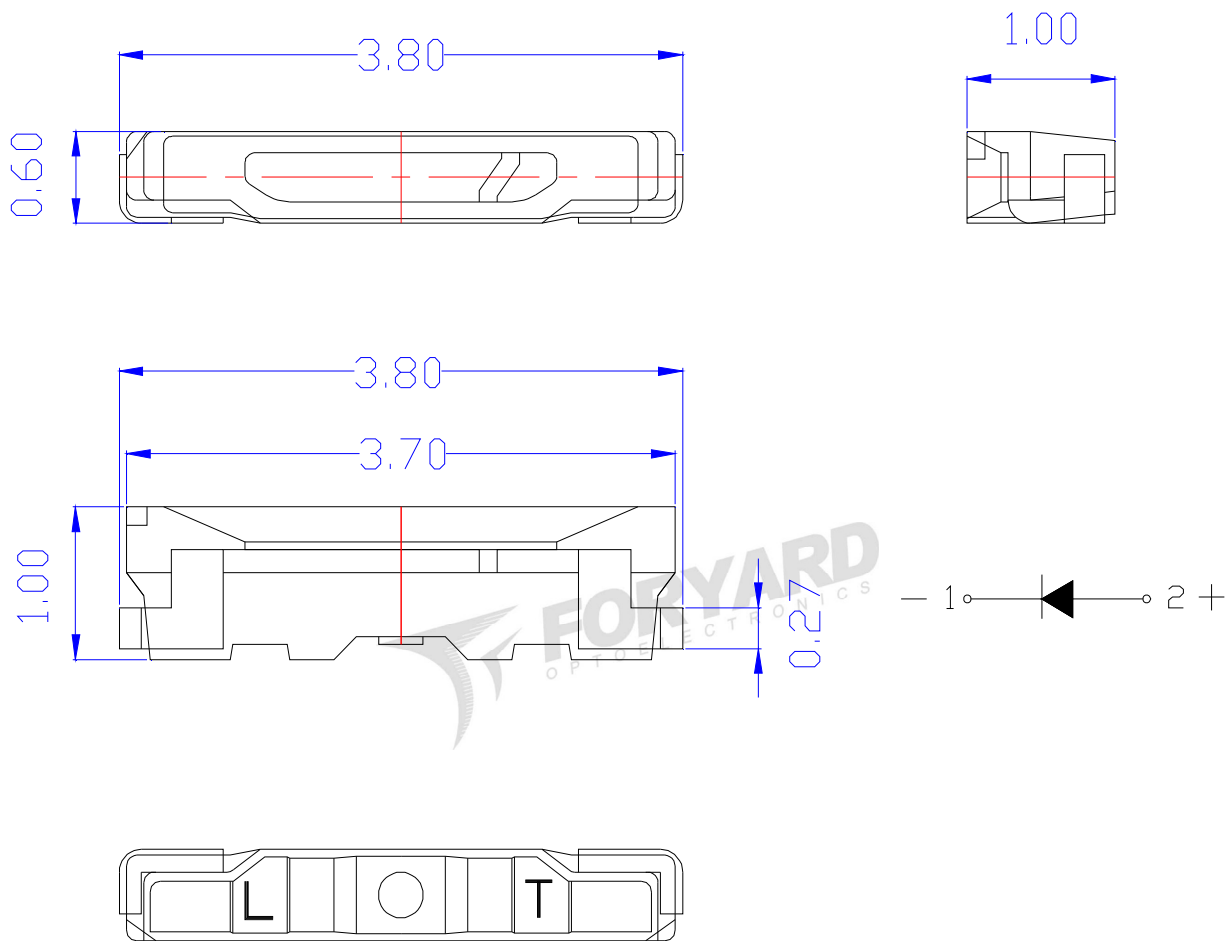
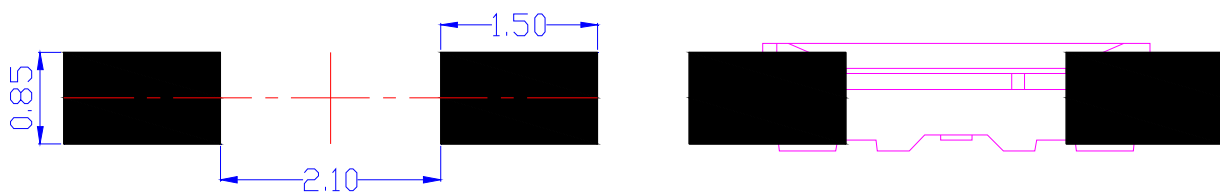
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**E-mail:**Sales@foryard.com ( General)

**Model No.: FYLS-3806BUWC120**
**■ Mechanical Dimensions**

**■ Recommend Soldering pad design(unit=mm)**

**Notes:**

1. Dimension in millimeter, tolerance is  $\pm 0.10$ .
2. Angle:  $\pm 5^\circ$
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The drawing is different from the actual one, please refer to the sample.

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**Absolute Maximum Ratings(Ta=25°C)**

Parameter	Symbol	MAX.	Unit
Power Dissipation	PD	100	mW
Peak Forward Current*	IFP	100	mA
Continuous Forward Current	IF	30	mA
Reverse Voltage	VR	5	V
Operating Temperature Range	Topr	-40~ +85	°C
Storage Temperature Range	Tstg	-40~ +85	°C

\*1/10 Duty Cycle, 0.1ms Pulse Width

**Typical Electrical & Optical Characteristics(Ta=25°C)**

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V <sub>F</sub>	IF=20mA	2.6	3	3.4	V
Reverse Current	I <sub>R</sub>	VR=5V	---	---	10	μA
Chromaticity coordinates	X	IF=20mA	---	0.28	---	---
	Y	IF=20mA	---	0.25	---	---
Color temperature	CCT	IF=20mA	---	12000	---	K
Luminous Intensity	I <sub>v</sub>	IF=20mA	3150	3450	3850	mcd
Viewing Angle	2θ <sub>1/2</sub>	IF=20mA	---	120	---	Deg

**Material**

Item	Reflector	Wire	Encapsulate	Chip
Material	PPA	Gold	Silicone	InGaN/GaN

Note:

- 1.Luminous Intensity is based on the Foryard standards.
- 2.Pay attention about static for InGaN

**The Luminous Intensity Grade of Products(Unit: mcd) ;Test Condition: If=20mA,Ta=25°C**

Code	40	41	42	43	44	45	46
Luminous Intensity(mcd)	3150~3250	3250~3350	3350~3450	3450~3550	3550~3650	3650~3750	3750~3850

Tolerance of measurement of luminous intensity is ±15%

**Forward Voltage Grade of Products (Unit: V); Test Condition: If=20mA,Ta=25°C**

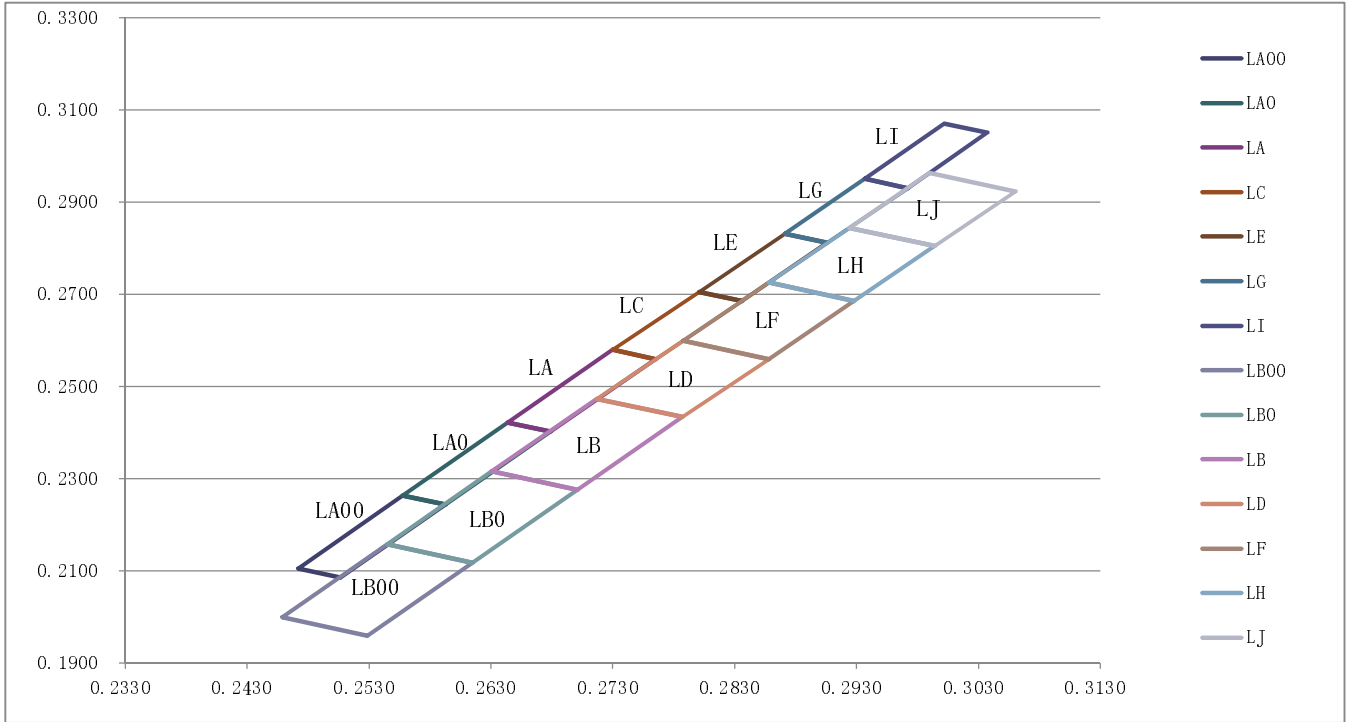
Code	6	7	8	9
Forward Voltage(V)	2.6~2.8	2.8~3.8	3.0~3.2	3.2~3.4

Tolerance of measurement of forward voltage is ±0.1V

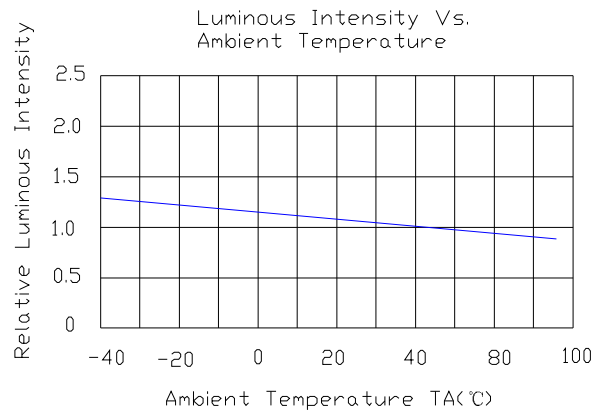
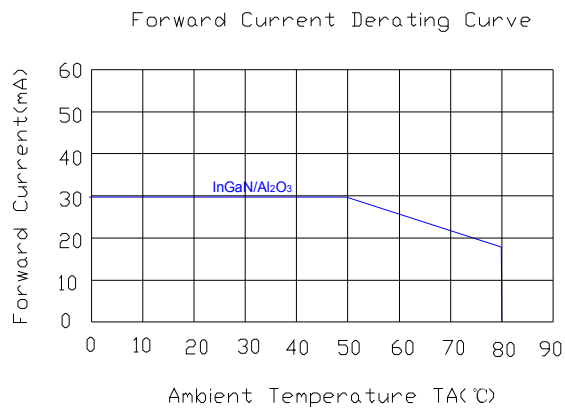
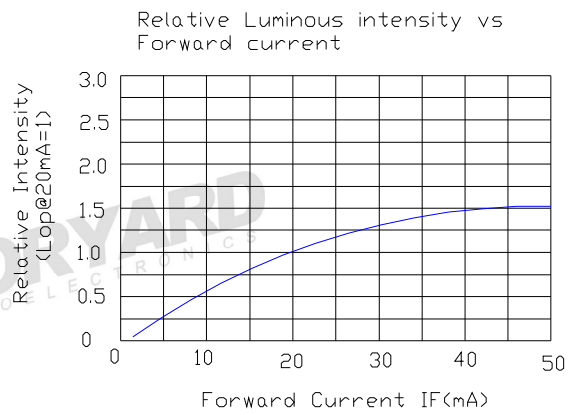
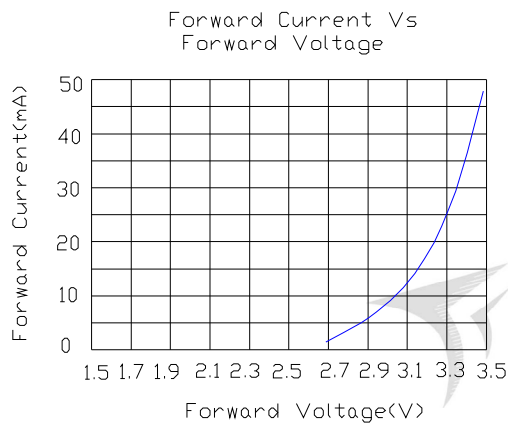
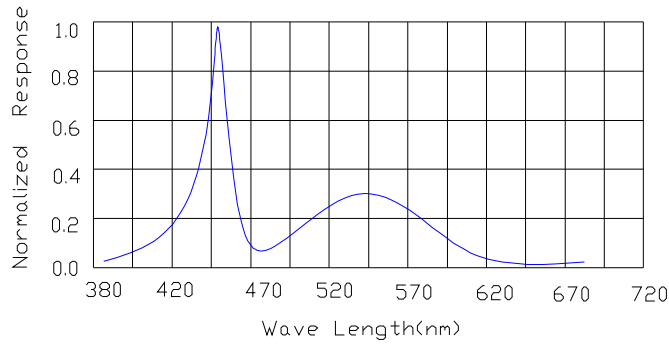
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**Chromaticity Coordinate Grade of White Chip-LED Products**

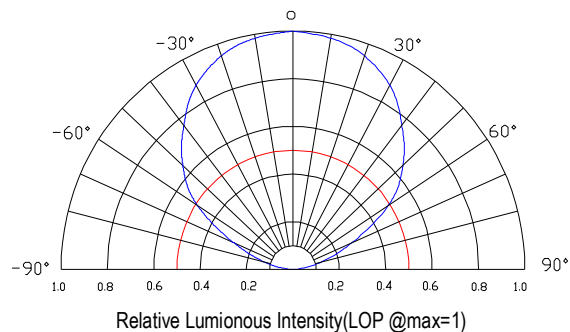
Test Condition: @IF=20mA Ta=25°C



BIN	CIE	Top	Right	Bottom	Left	BIN	CIE	Top	Right	Bottom	Left
LA00	X	0.2472	0.2558	0.2593	0.2507	LB00	X	0.2459	0.2545	0.2615	0.2529
	Y	0.2105	0.2263	0.2243	0.2085		Y	0.1999	0.2157	0.2117	0.1959
LA0	X	0.2558	0.2644	0.2679	0.2593	LB0	X	0.2545	0.2631	0.2701	0.2615
	Y	0.2263	0.2421	0.2401	0.2243		Y	0.2157	0.2315	0.2275	0.2117
LA	X	0.2644	0.2730	0.2765	0.2679	LB	X	0.2631	0.2717	0.2787	0.2701
	Y	0.2421	0.2579	0.2559	0.2401		Y	0.2315	0.2473	0.2433	0.2275
LC	X	0.2730	0.2801	0.2836	0.2765	LD	X	0.2717	0.2788	0.2858	0.2787
	Y	0.2579	0.2705	0.2685	0.2559		Y	0.2473	0.2599	0.2559	0.2433
LE	X	0.2801	0.2871	0.2906	0.2836	LF	X	0.2788	0.2858	0.2928	0.2858
	Y	0.2705	0.2831	0.2811	0.2685		Y	0.2599	0.2725	0.2685	0.2559
LG	X	0.2871	0.2937	0.2972	0.2906	LH	X	0.2858	0.2924	0.2994	0.2928
	Y	0.2831	0.2950	0.2930	0.2811		Y	0.2725	0.2844	0.2804	0.2685
LI	X	0.2937	0.3002	0.3037	0.2972	LJ	X	0.2924	0.2990	0.3060	0.2994
	Y	0.2950	0.3070	0.3050	0.2930		Y	0.2844	0.2963	0.2923	0.2804

**Model No.: FYLS-3806BUWC120**
**■ Electrical-Optical Characteristics-**


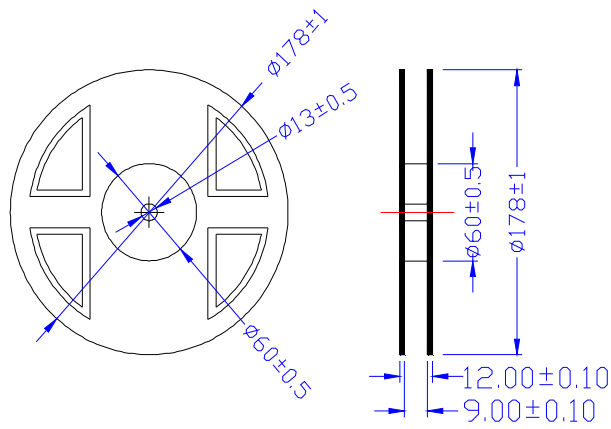
**NOTE:25°C free air temperature unless otherwise specified**

**■ Radiation pattern-**


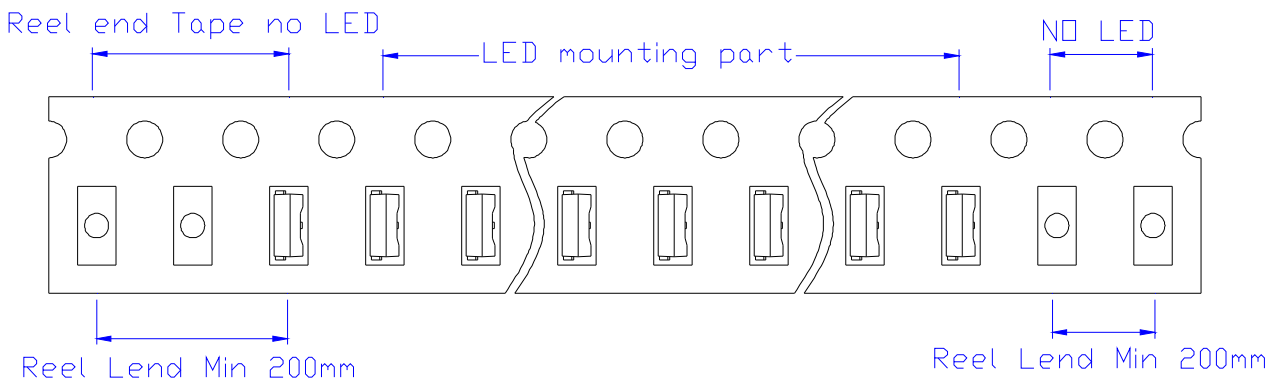
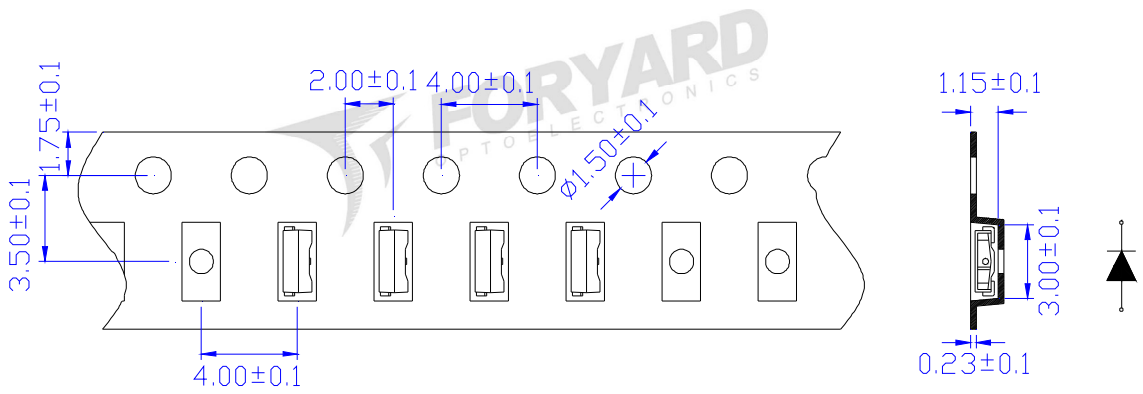
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**Package-**

1. Reel Dimension



2. Tape Dimension



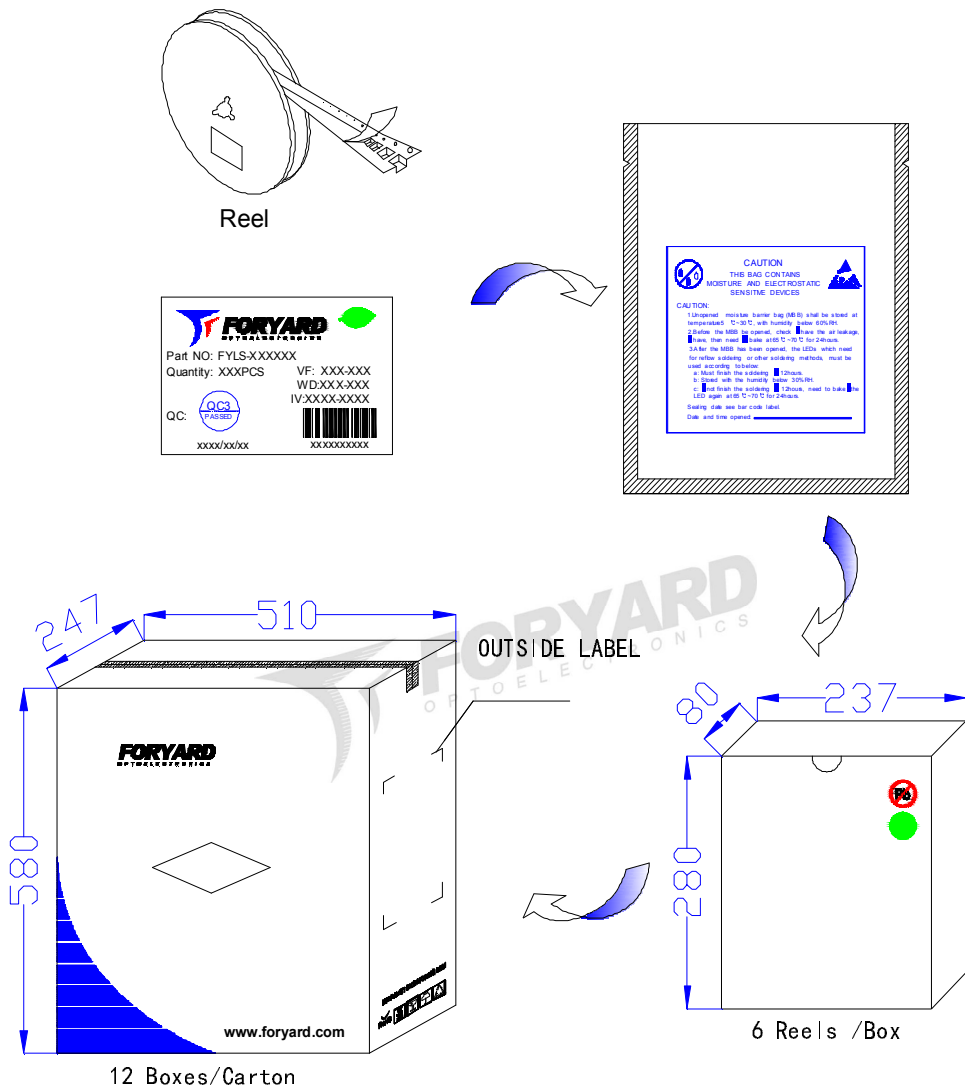
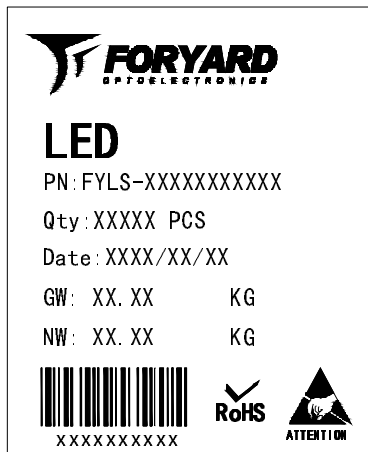
Notice:

1. Tolerance unless mentioned is  $\pm 0.2\text{mm}$

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3. Packing Diagram

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**LED**

PN: FYLS-XXXXXXXXXX

Qty: XXXXX PCS

Date: XXXX/XX/XX

GW: XX.XX KG

NW: XX.XX KG

XXXXXXXXXX

RoHS ATTENTION

OUTSIDE LABEL

Notice:

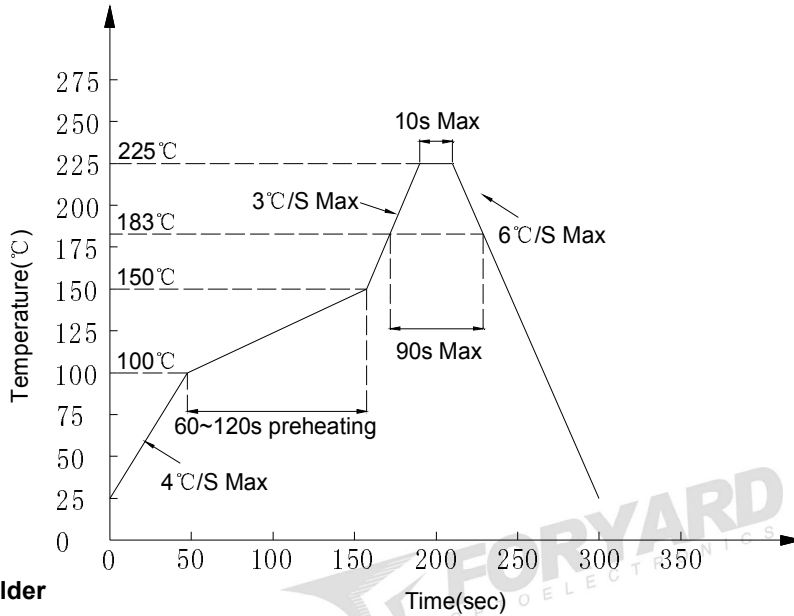
- 1.Quantity:4000 PCS/Reel
- 2.The specifications are subject to change without notice. Please contact us for updated information.

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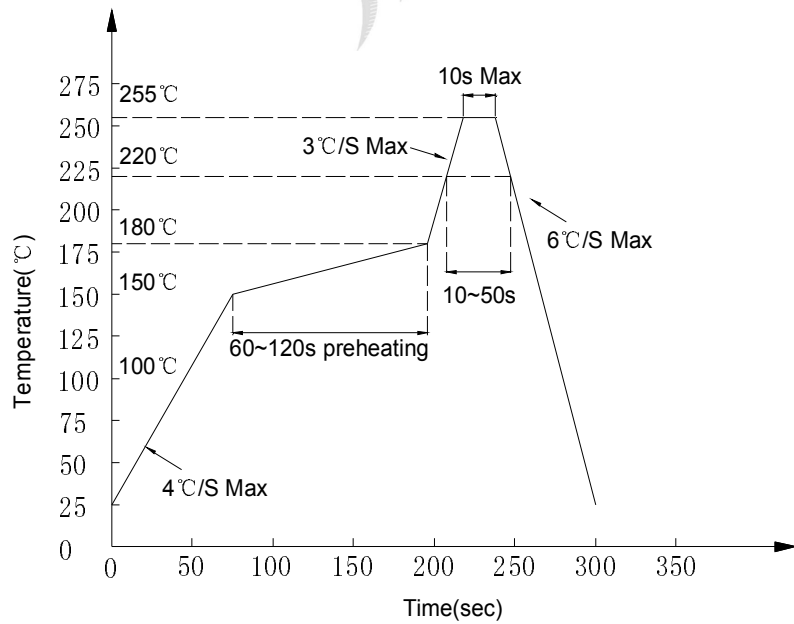
**■ Soldering Characteristics-**

**● Reflow Soldering**

**● Lead Solder**



**● Lead-free Solder**



**Notes:**

1. Although the recommended soldering conditions are specified in above table, reflow or hand soldering at the lowest possible temperature is desired for the LEDs.
2. A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
3. All temperatures refer to solder Pad.

**● Hand Soldering**

Soldering temperature	300°C Max. (25W Max.)	One time only
Soldering time	5 ±1sec	

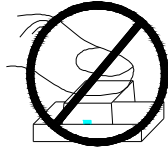


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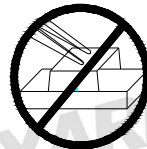
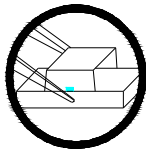
■ **Handling of Silicone Resin LEDs-**

● **Handling Indications**

When handling the product, do not touch it directly with bare hands as it may contaminate the surface and affect on optical characteristics. In the worst cases, excessive force to the product might result in catastrophic failure due to package damage and/or wire breakage.

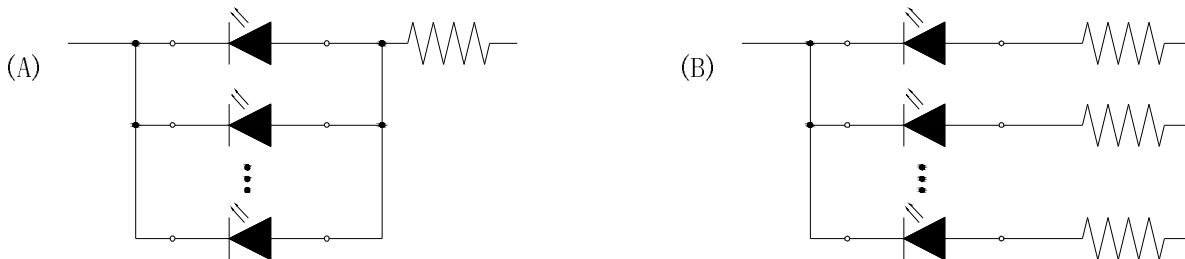


When handling the product with tweezers, LEDs should only be handled from the side and make sure that excessive force is not applied to the resin portion of the product. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed, and wire to be broken, and thus resulting in catastrophic failure.



■ **Recommended circuit-**

• In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LED with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage (VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.



• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product; such operation can cause migration resulting in LED damage.

■ **Storage-**

● **Storage Conditions**

1. Unopened moisture barrier bag (MBB) shall be stored at temperature below 5°C~30°C, with humidity below 60%RH.
2. Before the MBB be opened, check if have the air leakage, if have, then need to bake at 70°C±5°C for 24hours.
3. After the MBB has been opened, the LEDs which need for reflow soldering or other soldering methods, must be used according to below:
  - a: Must finish the soldering in 12hours
  - b: Stored with the humidity below 30%RH
  - c: If not finish the soldering in 12hours, need to bake the LED again at 70°C±5°C for 24hours